## E2 Technical Specifications

Raise3D E2 is a desktop 3D printer with independent dual extruders (also known as IDEX). IDEX gives Raise3D E2 the ability to perform more advanced functions, such as Mirror Mode and Duplication Mode, making this printer ideal for professional 3D printing. Its unique extruder gear design enables it to use flexible 3D printing materials, such as TPU, more reliably and with better results.

Printer	Raise3D E2				
Build Volume (W × D × H)	Single Extruder Print		Dual Extruder Print		
	330 × 240 × 240 mm (13 × 9.4 × 9.4 inch)		295 × 240 × 240 mm (11.6 × 9.4 × 9.4 inch)		
Machine Size (W × D × H)	607 × 596 × 465 mm (23.9 × 23.5 × 18.3 inch)				
Weight	Net Weight	Gross Weight (Carton Only)  Gross Weight (Carton with Palle			
	35.1 kg (77.4 lbs)	43.8 kg (	43.8 kg (96.6 lbs) 51.3		
Electrical	Power Supply Inpu Power Supply Outpu		100-240 V AC, 50/ 60 Hz 230 V @ 2 A 24 V DC, 350 W		
General	Print Technology Print Head System Filament Diamete XYZ Step Size Print Head Travel Speed Build Plate Max Build Plate Temperature Heated Bed Materia Build Plate Leveling Filament Run-out Senso Layer Heigh Nozzle Diamete Hot End Max Nozzle Temperature Connectivity Noise Emission (Acoustic Operating Ambient Temperature Storage Temperature Filte Technical Certifications	n IDEX Independent 1.75 mm 1.75 mm 2.78125, 0.781 3.0-150 mm/s 3.0-150 mm/s 4.110°C 3.11 Silicone 5.12 Mesh-leveling 6.13 Available 6.0.02-0.25 mm 6.24 mm (Defauted V3P 6.30°C 7.25 Wi-Fi, LAN, USE 6.30°C 8.30°C 8.30°C 9.4 Wi-Fi, LAN, USE 9.5 < 50 dB (A) white 15-30°C, 10-90 16-25°C to +55°C 17 HEPA filter with	0.78125, 0.78125, 0.078125 micron 30-150 mm/s Flexible Steel Plate with BuildTak 110°C Silicone Mesh-leveling with Flatness Detection Available 0.02-0.25 mm 0.4 mm (Default), 0.6/ 0.8 mm (Available) V3P		
Material	Material Type Third Party Materia	Glass Fiber Info	PLA/ ABS/ HIPS/ PC/ TPU/ TPE/ NYLON/ PETG/ ASA/ PP/ PVA/ Glass Fiber Infused/ Carbon Fiber Infused/ Metal Fill/ Wood Fill Supported by Raise3D OFP (Open Filament Program)*		
Software	Slicing Software Supported File Type: Supported OS Machine Code Type	s STL/ OBJ/ 3MF/ S Windows/ mac	STL/ OBJ/ 3MF/ OLTP Windows/ macOS/ Linux		
Printer Controller	User Interface Network Power Loss Recovery Screen Resolution Motion Controlle Logic Controlle Memory Onboard Flask Os	k Wi-Fi, Ethernet y Available n 1024 × 600 r Atmel ARM Cort r NXP ARM Cort y 1 GB n 16 GB	1024 × 600 Atmel ARM Cortex-M4 120 MHz FPU NXP ARM Cortex-A9 Quad 1 GHz 1 GB		

<sup>\*</sup>For detailed information and slicing profiles of the materials supported by Raise3D OFP, please visit <a href="https://www.ideamaker.io/">https://www.ideamaker.io/</a>.

